**Section 307.2302 Electroplating of Precious Metals**

a) Applicability. This Section applies to discharges resulting from the process in which a ferrous or nonferrous basis material is plated with gold, silver, iridium, palladium, platinum, rhodium, ruthenium, or any combination of these.

b) Specialized Definitions. The Board incorporates by reference 40 CFR 413.21 (2003). This incorporation includes no later amendments or editions.

c) Existing Sources

1) The Board incorporates by reference 40 CFR 413.24 (2003). This incorporation includes no later amendments or editions.

2) No person subject to the pretreatment standards incorporated by reference in subsection (c)(1) may cause, threaten, or allow the discharge of any contaminant to a POTW in violation of such standards.

d) Sources whose construction commenced after August 31, 1982 are subject to Subpart BH.

(Source: Amended at 47 Ill. Reg. 4662, effective March 23, 2023)